



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Kie Y. Ahn et al.

Title:

COPPER ELECTROLESS DEPOSITION TECHNOLOGY FOR ULSI METALIZATION

Docket No.: Filed:

1303.016US1 July 9, 2001

Serial No.: 09/901,001 Due Date: N/A

Group Art Unit: 1756

Examiner:

Commissioner for Patents Washington, D.C. 20231

We are transmitting herewith the following attached items (as indicated with an "X"):

 $\frac{X}{X}$ A return postcard.

An Information Disclosure Statement (1 pg.), Form 1449 (5 pgs.), and copies of 101 cited references.

A Communication Concerning Co-Pending Applications (2 pgs.).

Copies of Co-Pending Applications (6 copies.).

Please consider this a PETITION FOR EXTENSION OF TIME for sufficient number of months to enter these papers and please charge any additional required fees or credit overpayment to Deposit Account No. 19-0743.

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A.

P.O. Box 2938, Minneapolis, MN 55402 (612-373-6900)

Atty: Edward J. Brooks, III

Reg. No. 40,925

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Commissioner for Patents, Washington,

Gina M. Uphus

Name

Customer Number 21186

SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A. P.O. Box 2938, Minneapolis, MN 55402 (612-373-6900) (GENERAL)

BEST AVAILABLE COPY